

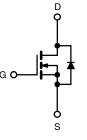


## **D** Series Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	450			
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6		
Q <sub>g</sub> max. (nC)	30			
Q <sub>gs</sub> (nC)	4			
Q <sub>gd</sub> (nC)	7			
Configuration	Single			

### D<sup>2</sup>PAK (TO-263)





N-Channel MOSFET

### **FEATURES**

- Optimal design
  - Low area specific on-resistance
  - Low input capacitance (Ciss)
  - Reduced capacitive switching losses
  - High body diode ruggedness
  - Avalanche energy rated (UIS)
- Optimal efficiency and operation
  - Low cost
  - Simple gate drive circuitry
  - Low figure-of-merit (FOM): Ron x Qa
  - Fast switching
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Consumer electronics - Displays (LCD or plasma TV)
- Server and telecom power supplies - SMPS
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	D <sup>2</sup> PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB10N40D-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	400			
Gate-Source Voltage		V	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	V <sub>GS</sub>	30			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	I <sub>D</sub>	10		
	$V_{GS}$ at 10 V $T_C = 100 \text{ °C}$		6	А	
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	23		
Linear Derating Factor			1.2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	194	mJ	
Maximum Power Dissipation		PD	147	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	24	V/ns	
Reverse Diode dV/dt <sup>d</sup>		uv/ul	0.6	v/ns	
Soldering Recommendations (Peak temperature) <sup>c</sup>	for 10 s		300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 2.3 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 13 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , starting  $T_J = 25 \ ^{\circ}C$ .

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1



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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62			°C ///				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 0.85				°C/W			
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherwi	ise noted)				1	1	1	
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	400	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 250 μΑ	-	0.53	-	V/°C	
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3	-	5	V	
Gate-Source Leakage	I <sub>GSS</sub>	\	$V_{\rm GS} = \pm 30$	V	-	-	± 100	nA	
		$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	<u> </u>		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V	', V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	μA		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I	<sub>D</sub> = 5 A	-	0.5	0.6	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub>	= 5 A	-	2.7	-	S	
Dynamic					•	•			
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	526	-	-	
Output Capacitance	C <sub>oss</sub>	- ·			-	59	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	9	-	pF		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 320 V		-	66	-			
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	84	-			
Total Gate Charge	Qq				-	15	30		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 V$ $I_D = 5 A, V_{DS} = 320 V$		-	4	-	nC	
Gate-Drain Charge	Q <sub>ad</sub>				-	7	-		
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 10 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	12	24	- ns		
Rise Time	t <sub>r</sub>			-	18	36			
Turn-Off Delay Time	t <sub>d(off)</sub>			-	18	36			
Fall Time	t <sub>f</sub>			-	14	28			
Gate Input Resistance	R <sub>q</sub>	f = 1 MHz, open drain		0.9	1.8	3.6	Ω		
Drain-Source Body Diode Characterist	Ű								
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	- A		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	40			
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V		
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 5 A, dl/dt = 100 A/ $\mu$ s <sup>, V</sup> <sub>B</sub> = 25 V		-	230	-	ns		
Reverse Recovery Charge	Q <sub>rr</sub>			-	1.6	-	μC		
Reverse Recovery Current	I <sub>RRM</sub>	di/dt =	100 A/µs <sup>, v</sup>	<sub>R</sub> = 25 V	_	14	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

Document Number: 91530



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

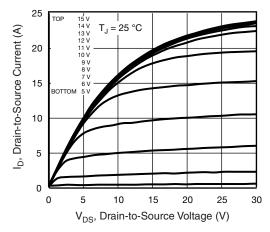


Fig. 1 - Typical Output Characteristics

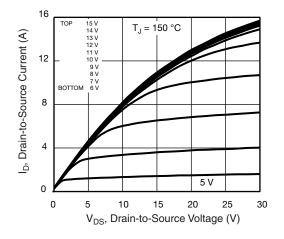


Fig. 2 - Typical Output Characteristics

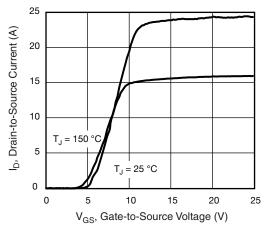


Fig. 3 - Typical Transfer Characteristics

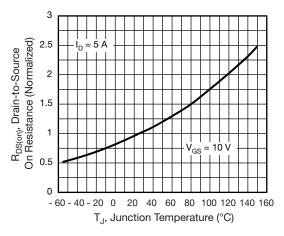


Fig. 4 - Normalized On-Resistance vs. Temperature

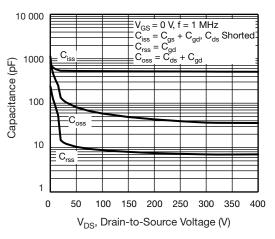
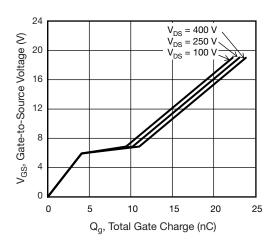
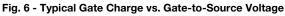


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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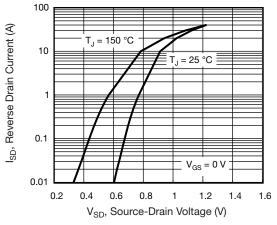
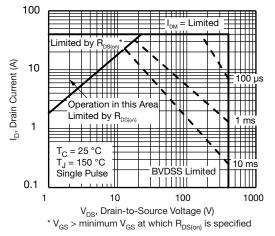
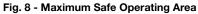


Fig. 7 - Typical Source-Drain Diode Forward Voltage





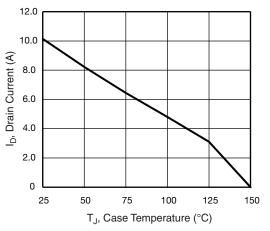


Fig. 9 - Maximum Drain Current vs. Case Temperature

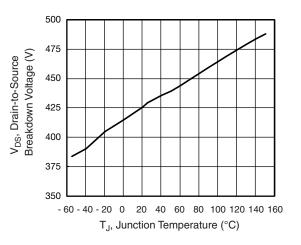
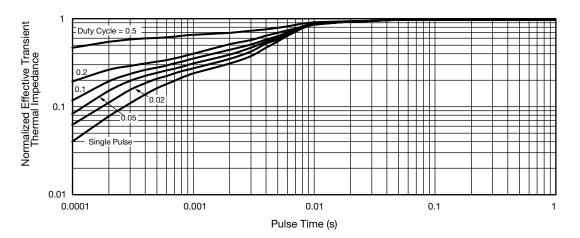


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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4

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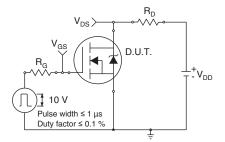


Fig. 12 - Switching Time Test Circuit

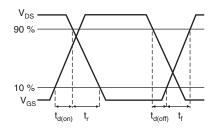


Fig. 13 - Switching Time Waveforms

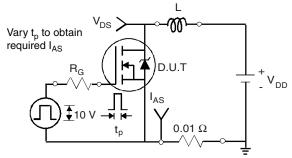


Fig. 14 - Unclamped Inductive Test Circuit

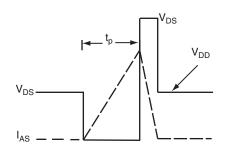
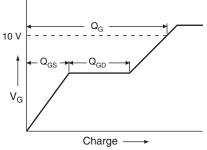


Fig. 15 - Unclamped Inductive Waveforms



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Fig. 16 - Basic Gate Charge Waveform

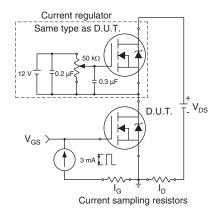
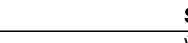
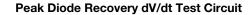


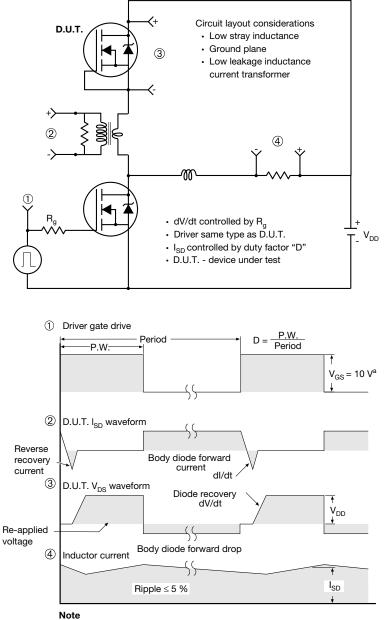
Fig. 17 - Gate Charge Test Circuit

5



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a.  $V_{GS} = 5$  V for logic level devices

Fig. 18 - For N-Channel

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